

Crystal oscillator

CRYSTAL OSCILLATOR (Programmable) OUTPUT: CMOS

SG-8200 series

- Frequency range
 - nge : 1.2 MHz to 170 MHz
- Supply voltage
- : 1.62 V to 3.63 V : Output enable (OE/OE) or Standby (ST/ST)
- Function : Output enable
- Frequency tolerance, operating temperature: ±50 × 10⁻⁶ (-40 °C to +125 °C)
- PLL technology to enable setting any output frequency



Product Number SG-8200CJ: X1G006211xxxx16 SG-8200CG: X1G006201xxxx16

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Item	Symbol	4.00\/.T	Specifications	2.20 \/ T	Condi	tions/Remark	S	
Supply voltage	V _{CC}	1.80 V Typ. 1.62 V to 1.98 V	2.50 V Typ. 2.25 V to 2.75 V	3.30 V Typ. 2.97 V to 3.63 V	_			
Output frequency range	fo	1.02 V to 1.00 V	1.2 MHz to 170 MHz					
Storage temperature	T stg		-55 °C to +150 °C		Storage as single product			
Operating temperature	T use		J: -40 °C to +125 °C		gg p	•		
Frequency tolerance ^{*1}	f tol		J: ±50 × 10 ⁻⁶		T use = -40 °C to +125 °C			
	1_101	5.2 mA Typ. 5.4 mA Typ. 5.6 mA Typ.						
		7.0 mA Max.	7.2 mA Max.	7.5 mA Max.	1.2 MHz ≤ f ₀ ≤ 25 MHz			
		5.4 mA Typ.	5.7 mA Typ.	6.1 mA Typ.		_		
		7.3 mA Max.	7.6 mA Max.	8.1 mA Max.	25 MHz < f ₀ ≤ 50 MHz			
		5.7 mA Typ.	6.3 mA Typ.	7.0 mA Typ.				
		7.7 mA Max.	8.2 mA Max.	9.1 mA Max.	–50 MHz < f ₀ ≤ 75 MHz		-No load, Rise/Fall time: Default 	
Current consumption	Icc	6.2 mA Typ.	6.9 mA Typ.	7.9 mA Typ.		—No load, Ri		
		8.2 mA Max.	9.1 mA Max.	10.4 mA Max.	−75 MHz < f ₀ ≤ 100 MHz			
		6.9 mA Typ.	7.9 mA Typ.	9.1 mA Typ.				
		9.4 mA Max.	10.7 mA Max.	12.4 mA Max.	- 100 MHz < f ₀ ≤ 125 MHz			
	-	7.8 mA Typ.	9.2 mA Typ.	11.2 mA Typ.				
		10.4 mA Max.	12.4 mA Max.	15.0 mA Max.	125 MHz < f ₀ ≤ 170 MHz			
		5.0 mA Typ.	5.0 mA Typ.	5.1 mA Typ.	l			
Output disable current	I_dis	7.2 mA Max.	7.3 mA Max.	7.4 mA Max.	$OE = GND, \overline{OE} = V_{CC}$			
		0.3 µA Typ.	0.3 µA Typ.	0.5 µA Typ.	ST = GND, ST = V _{CC}			
Standby current	I_std	15.0 µA Max.	15.0 μA Max.	15.0 µA Max.				
Symmetry	SYM	15.0 µA Max.	45 % to 55 %	13.0 μΑ Ινίαλ.	50 % Vas Loval L. CMOS	< 15 pE		
Symmetry	STIVI	45 % to 55 %			50 % V _{CC} Level, L_CMOS \leq 15 pF			
	Vон	90 % V _{CC} Min.			Rise/Fall time IoH IoL			
Output voltage	VOH				fo > 125 MHz	B: Faster	-2.0 mA	2.0 mA
Output voltage (DC characteristics)		10 % V _{CC} Max.			$75 \text{ MHz} < \text{fo} \le 125 \text{ MHz}$	C: Fast	-2.0 mA	1.0 mA
	Vol				$50 \text{ MHz} < \text{fo} \le 75 \text{ MHz}$	D: Slow	-0.5 mA	0.5 mA
	VOL				fo ≤ 50 MHz	E: Slower	-0.2 mA	0.2 mA
Output load condition	L CMOS		15 pF Max.					1
•	VIH	70 % V _{cc} Min.						
Input voltage	VIL		30 % V _{cc} Max.	Pin 1				
		-			Default 'A' Option*2	Other Options		
	tr/tf		2.0 ns Max.	fo > 125 MHz	B: Faster	20 % - 80 % Vcc,		
Rise/Fall time			2.5 ns Max.	75 MHz < fo ≤ 125 MHz	C: Fast			
			4.0 ns Max.	50 MHz < fo ≤ 75 MHz	D: Slow	$_$ L CMOS = 15 pF		
	-		6.0 ns Max.	fo ≤ 50 MHz	E: Slower	-		
Output disable time (OE)	tstp_oe				Measured from the time C		rosses 30	% Vcc
Output disable time (ST)	tstp_st		1 µs Max.		or measured from the time			
Output enable time (OE)	tsta_oe	100	ns + 2 clock cycle	Measured from the time C or measured from the time			√ _{cc}	
Output enable time (ST)	tsta_st	3 ms Max.			Measured from the time \overline{ST} pin crosses 70 % V_{CC} or measured from the time ST pin crosses 30 % V_{CC}			
Start-up time	t_str	3 ms Max.			Measured from the time V_{CC} reaches its rated minimum value, 1.62 V			
Phase Jitter	tрј	1.2 ps Typ.			fo = 25 MHz, Offset frequency: 12 kHz to 5 MHz			
		1.2 ps Typ.			fo = 50 MHz, Offset frequency: 12 kHz to 20 MHz			
		1.2 ps Typ.			fo = 75 MHz, Offset frequency: 12 kHz to 20 MHz			
		1.2 ps Typ.			fo = 100 MHz, Offset frequency: 12 kHz to 20 MHz			
		1.1 ps Typ.			fo = 125 MHz, Offset frequency: 12 kHz to 20 MHz			
		1.4 ps Typ.			fo = 150 MHz, Offset frequency: 12 kHz to 20 MHz			
		1.5 ps Typ.			fo = 170 MHz, Offset frequency: 12 kHz to 20 MHz			
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*1 Frequency tolerance includes initial frequency tolerance, temperature variation, supply voltage variation, reflow drift, load drift and aging (+25 °C, 1 year). *2 Default 'A' Rise/Fall time and I_{OH}/I_{OL} are dependent on programmed frequency.



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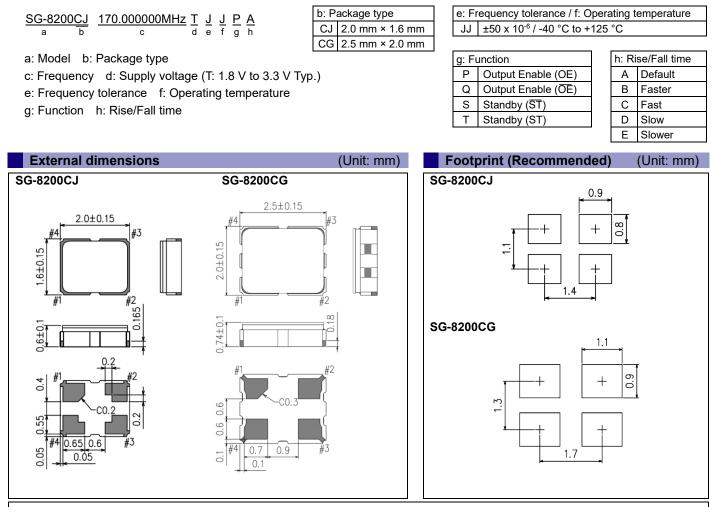
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P	Pin description								
Pin	Name	I/O type	Function						
	OE	Input	Output Enable	High ^{*1} or Open:	Specified frequency output from OUT pin				
	UE			Low:	OUT pin is low (pull down with 500 k Ω), only output driver is disabled.				
	ŌĒ	Input	Output Enable	Low ^{*2} or Open:	Specified frequency output from OUT pin				
	UE			High:	OUT pin is low (pull down with 500 k Ω), only output driver is disabled.				
1			Standby	High ^{*1 *3} :	Specified frequency output from OUT pin				
	ST	Input		Low:	OUT pin is low (pull down with 500 k Ω),				
					Device goes to standby mode. Supply current reduces to the least as I_std.				
		Input	Standby	Low*2 *3:	Specified frequency output from OUT pin				
	ST			High:	OUT pin is low (pull down with 500 k Ω),				
					Device goes to standby mode. Supply current reduces to the least as I_std.				
2	GND	Power	Ground						
3	OUT	Output	Clock output						
4	Vcc	Power	Power supply						

*1 If fixing it at High, please connect to V_{CC} directly.

*2 If fixing it at Low, please connect to GND directly. *3 If necessary to use Open, please select Output Enable function.

Product Name



Notes:

In order to achieve optimum jitter performance, the 0.01 μ F to 0.1 μ F capacitor between V_{CC} and GND should be placed. It is also recommended that the capacitors are placed on the device side of the PCB, as close to the device as possible and connected together with short wiring pattern.

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